

SGM2212 800mA, Low Noise, Low Quiescent Current, High PSRR, Low Dropout Linear Regulator

GENERAL DESCRIPTION

The <u>SGM2212</u> is a low noise, low quiescent current, high PSRR and low dropout voltage regulator with a dropout of 420mV at 800mA of load current.

The <u>SGM2212</u> is available in an adjustable version, which can set the output voltage from 1.25V to 15V with only two external resistors. In addition, it is available in five fixed voltages, 1.8V, 2.5V, 2.8V, 3.3V and 5V.

The <u>SGM2212</u> offers current limiting and thermal shutdown. A minimum of 1μ F ceramic capacitor is required at the output to improve the transient response and stability.

The <u>SGM2212</u> is available in Green SOT-223-3 and TDFN- $3\times3-8L$ packages. It operates over an ambient temperature range of -40°C to +125°C.

FEATURES

- Input Voltage Range: 2.7V to 20V
- Available in 1.8V, 2.5V, 2.8V, 3.3V, 5V and Adjustable Versions
- Current Limiting and Thermal Protection
- Output Current: 800mA
- Line Regulation: 0.03% (TYP)
- Load Regulation: 0.1% (TYP)
- -40°C to +125°C Operating Temperature Range
- Available in Green SOT-223-3 and TDFN-3×3-8L Packages

APPLICATIONS

Post Regulator for Switching DC-DC Converters High Efficiency Linear Regulators Portable Instrumentation

TYPICAL APPLICATION

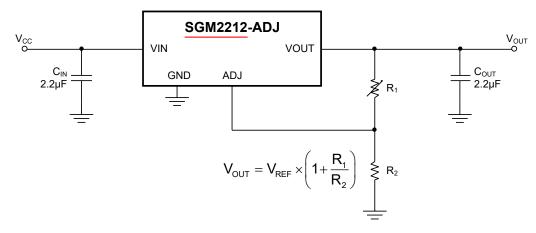


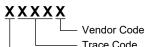
Figure 1. Typical Application Circuit

PACKAGE/ORDERING INFORMATION

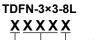
MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER		
<u>SGM2212</u> -3.3	SOT-223-3	-40°C to +125°C	SGM2212-3.3XKC3G/TR	MN4 XXXXX	Tape and Reel, 2500
<u>SGM2212</u> -5.0	SOT-223-3	-40°C to +125°C	SGM2212-5.0XKC3G/TR	MN5 XXXXX	Tape and Reel, 2500
SGM2212-ADJ	TDFN-3×3-8L	-40°C to +125°C	SGM2212-ADJXTDB8G/TR	SGM MN6DB XXXXX	Tape and Reel, 4000

MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code. **SOT-223-3**



— Trace Code — Date Code - Year



— Vendor Code — Trace Code — Date Code - Year

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Maximum Input Voltage (VIN to GND)	
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C

RECOMMENDED OPERATING CONDITIONS

Input Voltage Range	2.7V to 20V
Operating Temperature Range40°C	C to +125°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

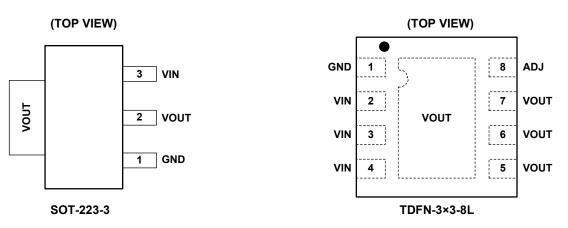
This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.



PIN CONFIGURATIONS



NOTE: When using the TDFN-3×3-8L package, Pins 2, 3 and 4 must be connected together and Pins 5, 6 and 7 must be connected together.

PIN DESCRIPTION

PIN		NAME	FUNCTION
SOT-223-3	TDFN-3×3-8L	NAME	FUNCTION
1	1	GND	Ground Pin for Fixed Output Option.
2	5, 6, 7	VOUT	Output Voltage Pin for the Regulator.
3	2, 3, 4	VIN	Input Voltage Pin for the Regulator.
_	8	ADJ	Adjust Pin for Adjustable Output Option.
_	Exposed Pad	VOUT	Connected to VOUT Pin.

ELECTRICAL CHARACTERISTICS

(At TA = +25°C, VIN = VOUT(NOM) + 1V, COUT = 2.2µF, IOUT = 100µA, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
Input Voltage	V _{IN}		+25°C	2.7		20	V
Reference Voltage	V _{REF}	SGM2212-ADJ, I _{OUT} = 10mA	+25°C		1.185		V
Output \/alta aa	Ň	SGM2212-3.3, I _{OUT} = 10mA	+25°C		3.3		V
Output Voltage	VOUT	SGM2212-5.0, I _{OUT} = 10mA	+25°C		5		V
	$\frac{\Delta V_{\text{out}}}{\Delta V_{\text{in}} \times V_{\text{out}}}$	<u>SGM2212</u> -ADJ, I _{OUT} = 10mA	+25°C		0.03		%/V
Line Regulation	ut Voltage VIN ference Voltage VREF SGI tput Voltage VOUT SGI tput Voltage V_{OUT} SGI e Regulation ΔV_{OUT} SGI ad Regulation ΔV_{OUT} SGI ΔV_{OUT} SGI SGI	SGM2212-3.3, I _{OUT} = 0mA	+25°C		1		mV
	Δv _{out}	<u>SGM2212</u> -5.0, I _{OUT} = 0mA	+25°C	3° C 2.7 20 V 5° C 2.7 20 V 5° C 1.185 V 5° C 3.3 V 5° C 5° V 5° C 5° V 5° C 5° V 5° C 1 mV 5° C 1 mV 5° C 0.1 $\%$ 5° C 0.1 mV 5° C 3.5 mV 5° C 3.5 mV 5° C 260 mV 5° C 260 mV 5° C 420 mV 5° C 900 mA 5° C 270 μ A 5° C 1400 μ A 5° C 10 n A			
Output Voltage		<u>SGM2212</u> -ADJ, $I_{OUT} = 0$ to 800mA	+25°C		0.1		%
	A) (SGM2212-3.3, I _{OUT} = 0 to 800mA	+25°C		3.5		mV
	Δv _{out}	<u>SGM2212</u> -5.0, I _{OUT} = 0 to 800mA	+25°C		3		mV
		I _{OUT} = 100mA	+25°C		50		mV
Dropout Voltage (1)	VDROP	I _{OUT} = 500mA	+25°C		260		mV
Input Voltage VIN Reference Voltage VRE Dutput Voltage Voltage Line Regulation $\frac{\Delta V_{OL}}{\Delta V_{IN} \times 1}$ Load Regulation $\frac{\Delta V_{OL}}{\Delta V_{OL}}$ Load Regulation $\frac{\Delta V_{OL}}{V_{OL}}$ Dropout Voltage ⁽¹⁾ V_{DRG} Dropout Voltage ⁽¹⁾ V_{DRG} Dutput Current Limit I_{LIN} Ground Pin Current I_{GNI} ADJ Pin Current I		I _{OUT} = 800mA	+25°C		420		mV
Output Current Limit	I _{LIM}	$V_{OUT} = 90\% V_{OUT(NOM)}$	+25°C		900		mA
	I _{GND}	I _{OUT} = 0mA	+25°C		80		μA
Ground Pin Current	I _{GND}	I _{OUT} = 100mA	+25°C		270		μA
Ground Pin Current	I _{GND}	I _{OUT} = 800mA	+25°C		1400		μA
ADJ Pin Current			+25°C		10		nA
RMS Output Noise		(% of V_{OUT}), f = 10Hz to 100kHz, I_{OUT} = 50mA	+25°C		0.002		%

NOTE:

1. The dropout voltage is defined as V_{IN} - V_{OUT} , when V_{OUT} falls 5% below the nominal value of V_{OUT} .



FUNCTIONAL BLOCK DIAGRAM

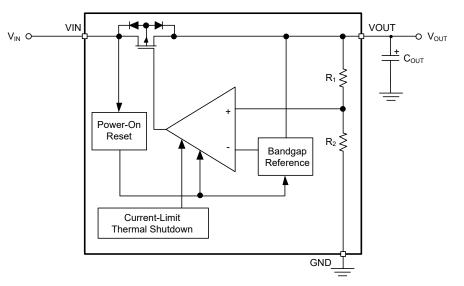


Figure 2. Fixed Output Regulator Block Diagram

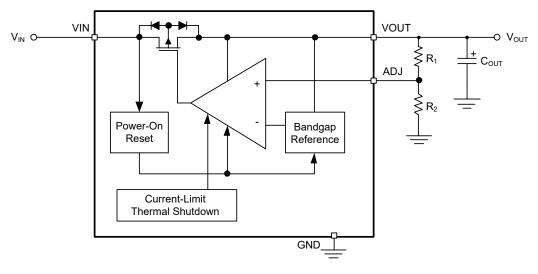


Figure 3. Adjustable Output Regulator Block Diagram

SGM2212

DETAILED DESCRIPTION

The <u>SGM2212</u> adjustable version develops a 1.185V voltage reference, V_{REF} . As shown in Figure 4, this feedback voltage is generated by resistor R₁ and R₂. The feedback voltage is compared with internal voltage reference and adjusts the output voltage.

For fixed voltage <u>SGM2212</u>, R_1 and R_2 are integrated inside the device.

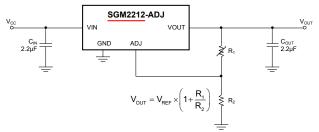


Figure 4. Adjustable Output Regulator

Load Regulation

The <u>SGM2212</u> regulates the voltage that appears between its output and ground pins. In some cases, line resistances can introduce errors to the voltage across the load. To obtain the best load regulation, a few precautions are needed.

Figure 5 shows a typical application using a fixed output regulator. The R_{t1} and R_{t2} are the line resistances. It is obvious that the V_{LOAD} is less than the V_{OUT} by the sum of the voltage drops along the line resistances. In this case, the load regulation seen at the R_{LOAD} would be degraded from the datasheet specification. To improve this, the load should be tied directly to the output terminal on the positive side and directly tied to the ground terminal on the negative side.

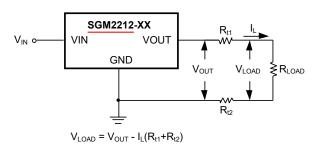
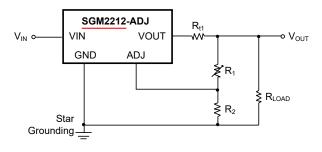


Figure 5. Typical Application Using Fixed Output Regulator

When the adjustable regulator is used (Figure 6), the best performance is obtained with the positive side of the resistor R₁ tied directly to the load, then the line drops will be eliminated. For example, a 5V regulator with 0.05 Ω resistance between the regulator and load will have a load regulation due to line resistance of 0.05 $\Omega \times I_L$. In addition, the ground side of the resistor R₂ can be returned near the ground of <u>SGM2212</u> to provide remote ground sensing and improve load regulation.



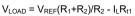


Figure 6. Best Load Regulation Using Adjustable Output Regulator



APPLICATION INFORMATION

The SGM2212 is a versatile and high performance linear regulator with a wide temperature range and tight line/load regulation operation. An output capacitor is required to further improve transient response and stability. The SGM2212 is versatile in its applications, including its uses as a post regulator for DC/DC converters, battery chargers and microprocessor supplies.

Design Requirements

The device component count is very minimal, employing two resistors as part of a voltage divider circuit and an output capacitor for load regulation. A 1μ F or 10μ F on the input is a suitable input capacitor for almost all applications.

Detailed Design Procedure

The output voltage is set based on the selection of the two resistors, R_1 and R_2 , as shown in Figure 4. For details on capacitor selection, refer to External Capacitors section.

External Capacitors

An input capacitor is recommended. A 1μ F ceramic capacitor on the input is a suitable input capacitor for almost all applications.

Output Capacitor

Input Bypass Capacitor

An output capacitor is required between VOUT and GND to prevent oscillation. The minimum size of the output capacitor is 1μ F. Larger values improve the regulator's transient response.



SGM2212

POWER SUPPLY RECOMMENDATIONS

The input supply to the <u>SGM2212</u> must be kept at a voltage level such that its maximum rating is not exceeded. The minimum dropout voltage must also be met with extra headroom when possible to keep the

LAYOUT

Layout Guidelines

Some layout guidelines must be followed to ensure proper regulation of the output voltage with minimum noise. In cases when VIN shorts to ground, an external diode must be placed from VOUT to VIN to divert the surge current from the output capacitor and protect the IC. The diode must be placed close to the corresponding IC pins to increase their effectiveness.

When an integrated circuit operates with an appreciable current, its junction temperature is elevated. It is important to quantify its thermal limits in order to achieve acceptable performance and reliability. This limit is determined by summing the individual parts consisting of a series of temperature rises from the semiconductor junction to the operating environment. The heat generated at the device junction flows through the die to the die attach pad, through the lead frame to the surrounding case material, to the printed circuit board, and eventually to the ambient environment. Below is a list of variables that may affect the thermal resistance and in turn the need for a heatsink.

Table 1. Component and Application	on Variables
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R _{eJC} (COMPONENT VARIABLES)	R _{0JA} (APPLICATION VARIABLES)
Leadframe Size and Material	Mounting Pad Size, Material, and Location
No. of Conduction Pins	Placement of Mounting Pad
Die Size	PCB Size and Material
Die Attach Material	Traces Length and Width
Molding Compound Size and Material	Adjacent Heat Sources
	Volume of Air
	Ambient Temperatue
	Shape of Mounting Pad

SGM2212 in regulation. An input capacitor is recommended. For more information regarding capacitor selection, refer to External Capacitors.

The <u>SGM2212</u> regulators have internal thermal shutdown to protect the device from over-heating. Under all possible operating conditions, the junction temperature of the <u>SGM2212</u> must be within the range of -40 °C to +125 °C. A heatsink may be required depending on the maximum power dissipation and maximum ambient temperature of the application. To determine if a heatsink is needed, the power dissipated by the regulator, P_D, must be calculated:

$$I_{\rm IN} = I_{\rm L} + I_{\rm G} \tag{1}$$

$$P_D = (V_{IN} - V_{OUT})I_L + V_{IN}I_G$$
(2)

Figure 7 shows the voltages and currents which are present in the circuit.

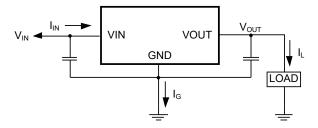


Figure 7. Power Dissipation Diagram

The next parameter which must be calculated is the maximum allowable temperature rise, $T_{R(max)}$:

$$T_{R(max)} = T_{J(max)} - T_{A(max)}$$
(3)

where

• $T_{J(max)}$ is the maximum allowable junction temperature (+125°C) which will be encountered in the application.

• $T_{A(max)}$ is the maximum ambient temperature which will be encountered in the application.

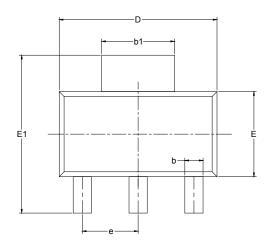
Using the calculated values for $T_{R(max)}$ and P_D , the maximum allowable value for the junction-to-ambient thermal resistance ($R_{\theta JA}$) can be calculated:

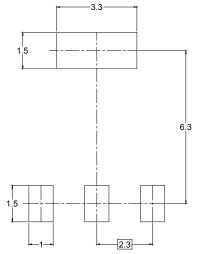
$$R_{\theta JA} = T_{R(max)}/P_D \tag{4}$$



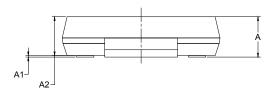
PACKAGE OUTLINE DIMENSIONS

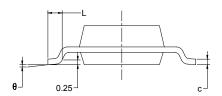
SOT-223-3





RECOMMENDED LAND PATTERN (Unit: mm)



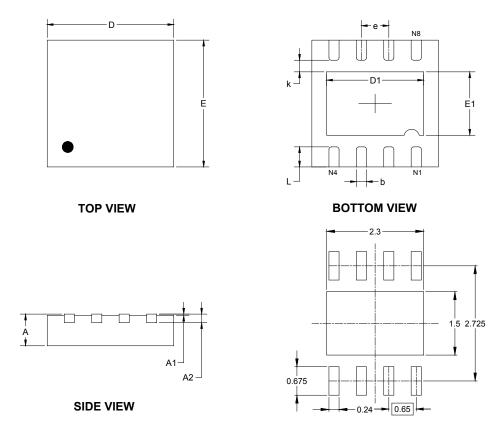


Symbol	-	nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
A		1.800		0.071	
A1	0.020	0.100	0.001	0.004	
A2	1.500	1.700	0.059	0.067	
b	0.660	0.840	0.026	0.033	
b1	2.900	3.100	0.114	0.122	
С	0.230	0.350	0.009	0.014	
D	6.300	6.700	0.248	0.264	
E	3.300	3.700	0.130	0.146	
E1	6.700	7.300	0.264	0.287	
e	2.300 BSC		0.091	BSC	
L	0.750		0.030		
θ	0°	10°	0°	10°	



PACKAGE OUTLINE DIMENSIONS

TDFN-3×3-8L



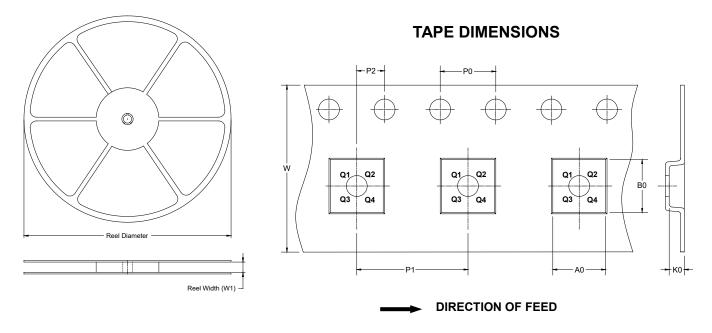
RECOMMENDED LAND PATTERN (Unit: mm)

Symbol		nsions meters	Dimensions In Inches		
2	MIN	MAX	MIN	MAX	
A	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A2	0.203	B REF	0.008	REF	
D	2.900	3.100	0.114	0.122	
D1	2.200	2.400	0.087	0.094	
E	2.900	3.100	0.114	0.122	
E1	1.400	1.600	0.055	0.063	
k	0.200) MIN	0.008	3 MIN	
b	0.180	0.300	0.007	0.012	
е	0.650	0.650 TYP		TYP	
L	0.375	0.575	0.015	0.023	



TAPE AND REEL INFORMATION

REEL DIMENSIONS

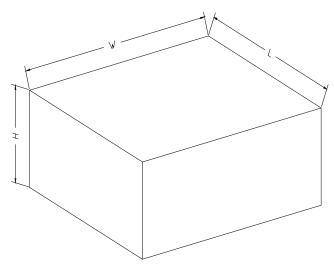


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-223-3	13″	12.4	6.55	7.25	1.90	4.0	8.0	2.0	12.0	Q3
TDFN-3×3-8L	13″	12.4	3.35	3.35	1.13	4.0	8.0	2.0	12.0	Q1

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
13″	386	280	370	5	DD0002



单击下面可查看定价,库存,交付和生命周期等信息

>>SGMICRO(圣邦微电子)